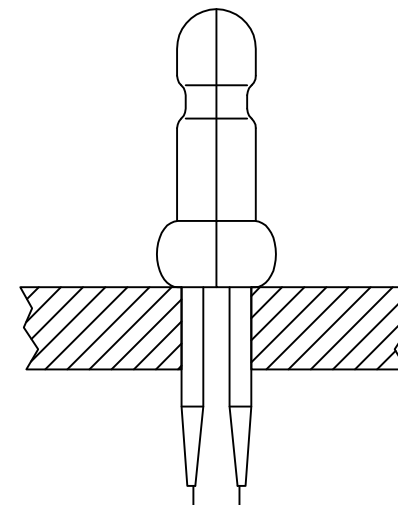
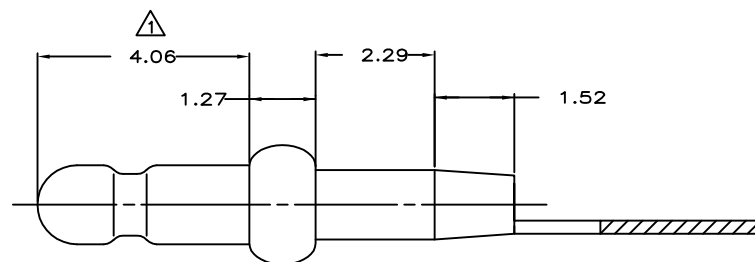
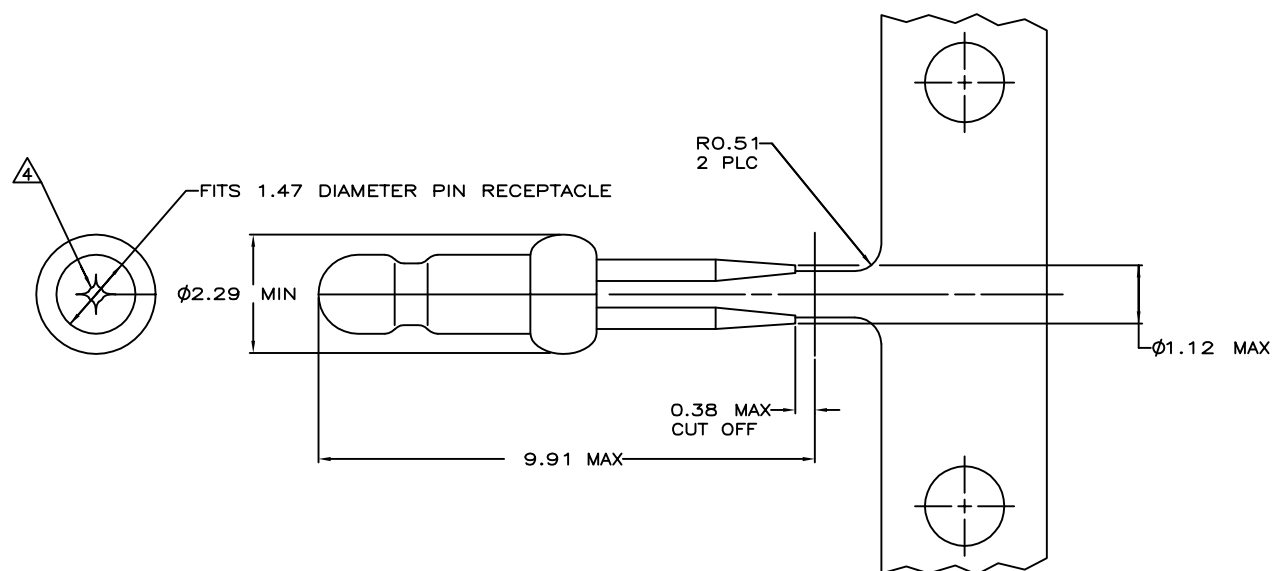




1. 0.00076 MIN GOLD PLATING IN THIS AREA WITH 0.00381 MIN MATTE TIN LEAD ON THE REMAINDER, BOTH OVER 0.00127 MIN NICKEL UNDERPLATE.
2. FITS 1.17 - 1.27 DIAMETER HOLE IN A 1.57 OR 2.36 PRINTED CIRCUIT BOARD.
3. PARTS TO COMPLY WITH AMP SOLDERABILITY SPECIFICATION 109-11-3.
4. 0.05 - 0.25 DIAMETER OPENING REQUIRED IN TIP OF PIN.
5. APPLICATOR FEED: 8.00 - 8.26
6. 0.00076 MIN GOLD PLATING IN THIS AREA WITH 0.00381 MIN MATTE TIN ON THE REMAINDER, BOTH OVER 0.00127 MIN NICKEL UNDERPLATE.

0.13	.005	1.17	.046	2.29	.090	9.91	.390
0.05	.002	1.12	.044	1.57	.062	8.26	.325
0.00381	.000150	0.51	.020	1.52	.060	8.00	.315
0.00127	.000050	0.38	.015	1.47	.058	4.06	.160
0.00076	.000030	0.25	.010	1.27	.050	2.36	.093
MM	IN	MM	IN	MM	IN	MM	IN

1471-9 (1/15)

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